

Single Channel Silicon ESD Protector Overvoltage Protection Device

Specification Status: Preliminary

BENEFITS

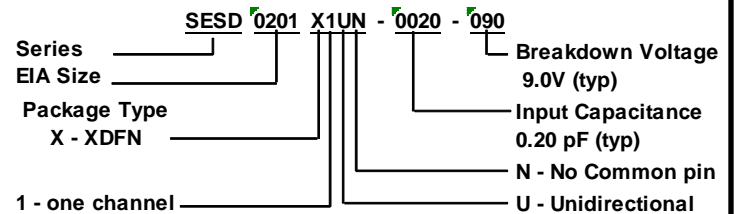
- Industry-leading lowest capacitance; provides lowest insertion loss for high speed data signals
- Small size ESD protection diodes for high speed data signals (0201 size devices)
- Helps protect electronic circuits against damage from Electrostatic Discharge (ESD), surge and cable discharge events
- Assists equipment to pass IEC61000-4-2, level 4 testing

FEATURES

- Low capacitance: 0.20 pF (typ, uni-di)
- Low leakage current: 50nA @ 5V (max)
- Low clamping voltage: +9.18 / -0.8V (typ, uni-di) @ (tp=8x20µs, Ipp=2A)
- ESD maximum rating per IEC61000-4-2 standard:
 - ± 20kV contact discharge
 - ± 20kV air discharge
- Surge : 2A (max, uni-di) @ (tp=8x20µs) per IEC61000-4-2-5
- Small size and low profile: XDFN packages



PART NUMBERING



APPLICATIONS

- Consumer, mobile and portable electronics
- Tablet PC and external storage with high speed interfaces
- Ultra-high speed data lines
- USB 3.0/2.0, HDMI 1.3/1.4, DisplayPort, Thunderbolt (Light Peak), V-by-One HS, and LVDS interfaces
- Applications requiring high ESD performance in small packages

MATERIALS INFORMATION

RoHS Compliant ELV Compliant Halogen Free * Lead Free

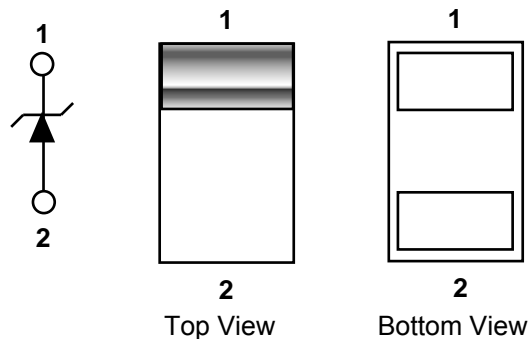
Directive 2000/53/EC
Compliant

Directive 2002/95/EC
Compliant



* Halogen Free refers to: Br≤900ppm, Cl≤900ppm, Br+Cl≤1500ppm
SESD devices meet MSL-1 Requirements
DFN case epoxy meets UL 94 V-0

SCHEMATIC AND PIN CONFIGURATION



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DEVICE MAXIMUM RATING

ESD Withstand ⁽¹⁾ (IEC 61000-4-2, level 4)		Temperature		Peak Current (tp=8x20µs)
Contact (kV)	Air (kV)	Operating (°C)	Storage (°C)	Ipp (A)
± 20	± 20	-55 to +125	-55 to +150	2.0

⁽¹⁾ 20kV @ ± 1 pulse; 10kV @ ± 50 pulses; 8kV @ 1,000 pulses (under IEC6100-4-2)

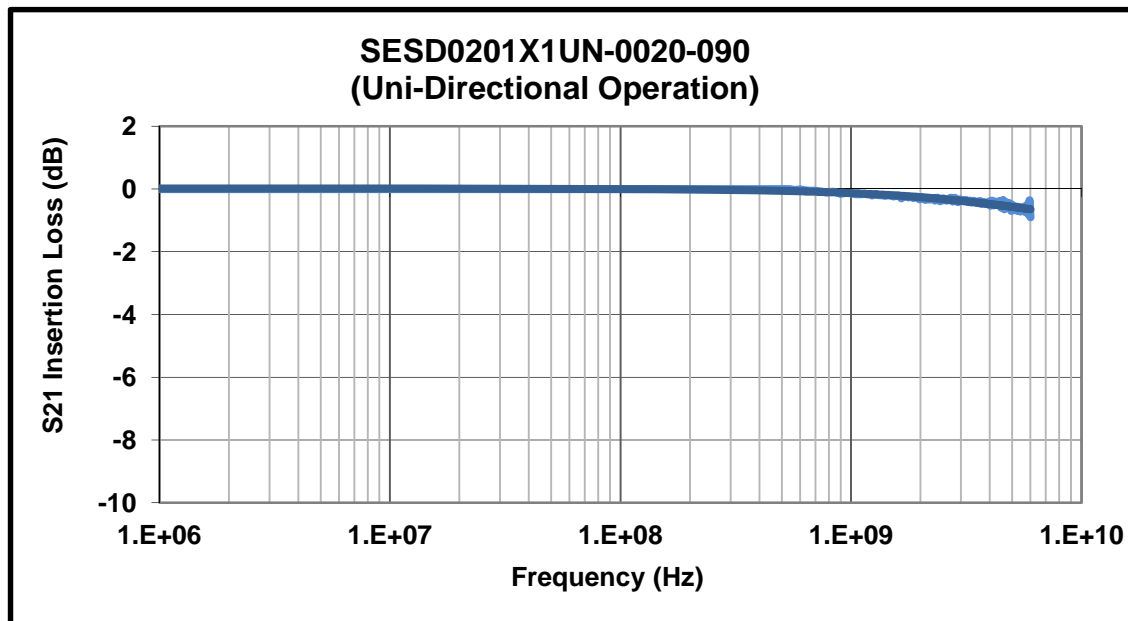
- Device maximum rating @ T = 25°C, unless otherwise specified
- Caution: Stress exceeding Device Maximum Ratings may damage the device
Prolonged exposure to stresses above the recommended operating conditions may affect device reliability

DEVICE ELECTRICAL CHARACTERISTICS

Input Capacitance @ V _R = 0V, f = 3GHz (pF)		Breakdown Voltage V _{BR} @ I _T =1mA (V)	Reverse Working Voltage (V)		Reverse Leakage Current I _L @ V _{WRV} =5.0V (nA)		Clamping Voltage V _{CL} @ Ipp=2.0A (V)
Typ	Maximum	Typ	Min	Max	Typ	Max	Max
0.20	0.22	+9.00 / -0.80	0	+8.00	<5.0	50.0	+9.18 / -0.80

- All device electrical characteristics @ T = 25°C, unless otherwise specified

FIGURE 1. INSERTION LOSS DIAGRAM



Application	Bit Rate (Gbps)	@Freq (GHz)	Ins. Loss (dB)
HDMI 1.4 (1080P)	2.25	1.13	-0.15
DisplayPort	2.70	1.35	-0.20
HDMI 1.4 (max spec)	3.40	1.70	-0.23
USB3.0	5.00	2.50	-0.29
eSATA	6.00	3.00	-0.35
Thunderbolt	10.0	5.00	-0.50

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FIGURE 2. DEVICE IV CURVE

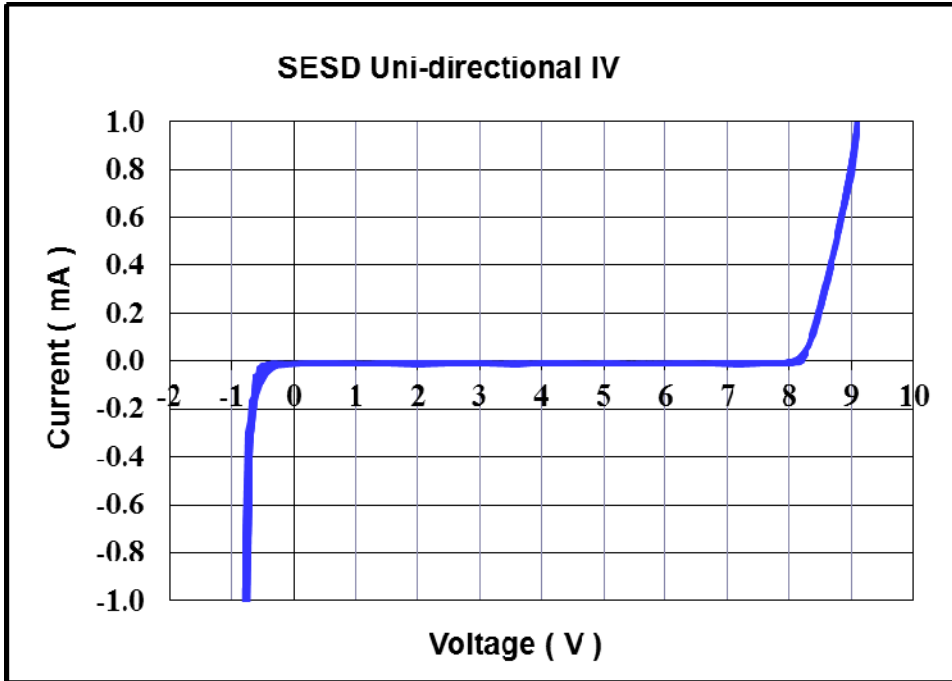
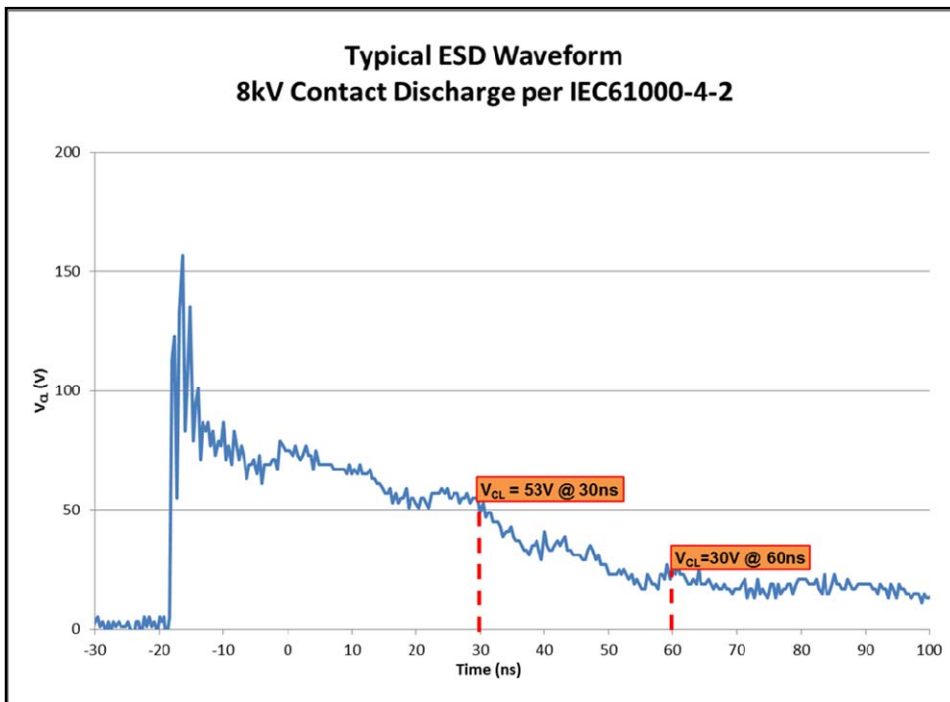


FIGURE 4. ESD WITHSTAND

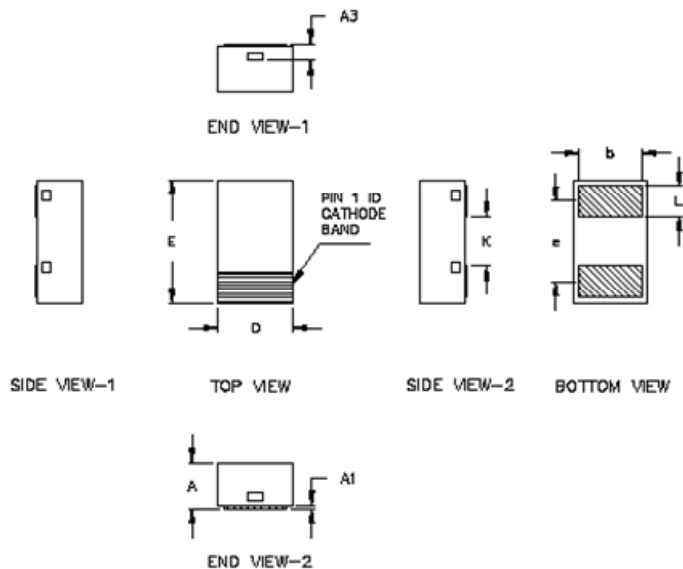


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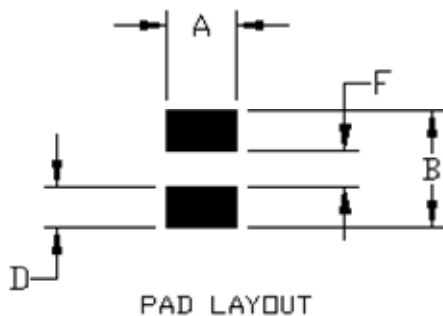
DEVICE DIMENSIONS



Dim	Millimeters (mm)			Inches (in)		
	Min	Nom	Max	Min	Nom	Max
A	0.30	0.31	0.32	0.0115	0.0122	0.0125
A1	0	-	0.05	0	-	0.0020
A3	0.102 ref.			0.0040 ref.		
D	0.285	0.320	0.355	0.0112	0.0120	0.0139
E	0.585	0.620	0.655	0.0230	0.0244	0.0237
K	0.130	0.155	0.180	0.0052	0.0061	0.0071
b	0.235	0.260	0.285	0.0083	0.0102	0.0112
L	0.175	0.200	0.225	0.0069	0.0079	0.0088
e	0.355 BSC			0.014 BSC		

BSC – Basic Spacing between Centers

RECOMMENDED LANDING PATTERN:



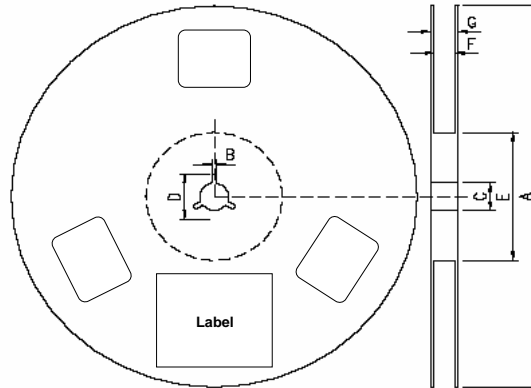
SESD Landing Pad Layout 0201 Package		
Symbol	Millimeters (mm)	Inches (in)
A	0.32	0.013
B	0.62	0.024
D	0.24	0.009
F	0.14	0.006

PACKAGING

Packaging	Tape & Reel	Standard Box
SESD0201X1UN-0020-090	15,000	75,000

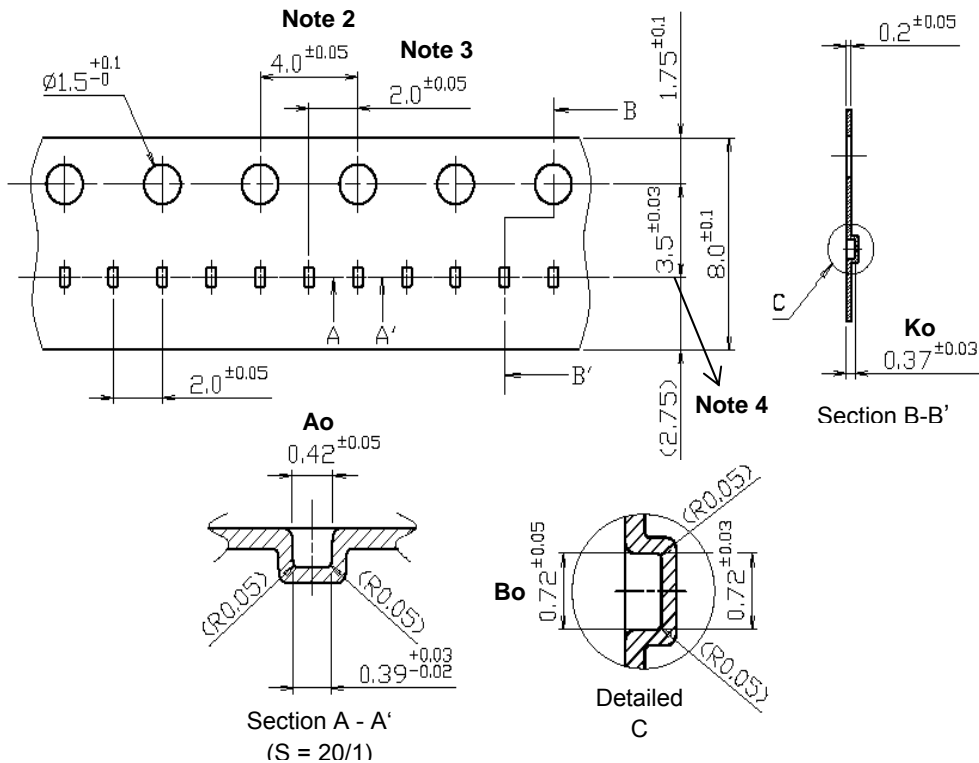
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REEL DIMENSIONS



Dimensions	A	B	C	D	E	F	G
(mm)	180.0 ± 1.5	2.3. 0 ± 0.2	13.0 + 0.5 / -0.2	17.3 ± 0.2	60.5 ± 1.5	8.4 +1.5/-0.0	14.4 (max)

CARRIER TAPE DIMENSIONS



Ao	0.42 ± 0.05
Bo	0.72 ± 0.05
Ko	0.37 ± 0.05

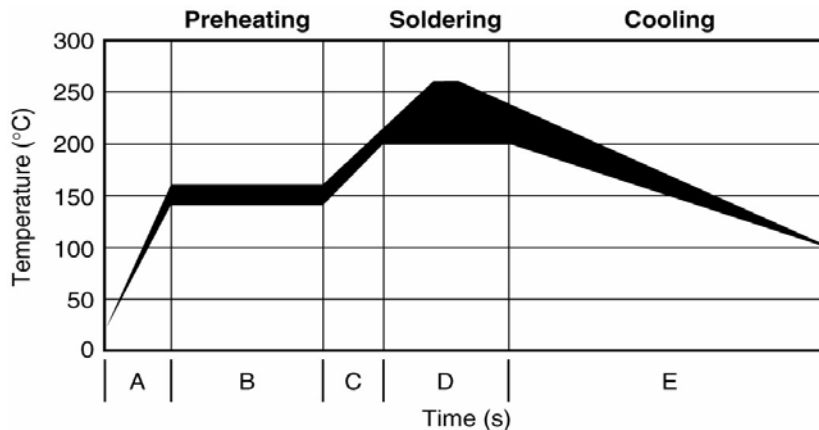
- Note 1. All dimensions in mm
Note 2. Cumulative tolerance is 200 ± 0.3 / 50MM pitch
Note 3. Center point of hole tolerance is 2.0 ± 0.5
Note 4. Center point of hole tolerance is 3.5 ± 0.5

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SOLDER REFLOW RECOMMENDATION

A	Temperature ramp up 1	From ambient to Preheating temperature	30s to 60s
B	Preheating	140°C - 160°C	60s to 120s
C	Temperature ramp up 2	From Preheating to Main heating temperature	20s to 40s
D	Main heating	at 200°C at 220°C at 240°C at 260°C	60s ~ 70s 50s ~ 60s 30s ~ 40s 5s ~ 10s
E	Cooling	From main heating temperature to 100°C	4°C/s (max)

FIGURE 5. REFLOW PROFILE



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